Specifications

Drawing No.	UKY1C-H2-25AAA-00[37] 1/10
Issued Date.	2025/06/30

TO:

Note:

In case of specification change, KYOCERA Part Number also will be changed.

Product Type	Quartz Crystal	
Series	CX3225SA	
Frequency	40000 kHz	
Customer Part Number	-	
Customer Specification Number	-	
KYOCERA Part Number	CX3225SA40000D0GTVHH	
Remarks Pb-Free, RoHS Compliant, MSL 1, AEC-Q200 Compliant		

Customer Approval

Approval Signature	Approved Date
	Department
	Person in charge

Seller

KYOCERA Corporation Corporate Electronic Components Group Electronic Components Sales Division Manufacturer

RF Devices Division Corporate Electronic Components Group Crystal Components Division

6 Takeda Tobadono-cho, Fushimi-ku, Kyoto 612-8501 Japan TEL. No. 075-604-3500 FAX. No. 075-604-3501

Design Department	Quality Assurance	Approved by	Checked by	Checked by	Issued by
KYOCERA Corporation Crystal Components Application Engineering Section 2 Electronic Devices Division Corporate Electronic Components Group	-	-	-	-	-

Drawing No.	UKY1C-H2-25AAA-00[37]	2/10
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Revision History

Rev.No.	Description of revision	Date	Approved by	Checked by	Issued by
00	First Edition	2025/06/30	-	-	-

1 APPLICATION

This specification sheet is applied to quartz crystal "CX3225SA40000D0GTVHH"

2 KYOCERA PART NUMBER

CX3225SA40000D0GTVHH

3 RATINGS

Items	Symb.	Rating	Unit	Remarks
Operating Temperature Range	Topr	-40 to +150	°C	
Storage Temperature Range	Tstg	-40 to +150	°C	

4 CHARACTERISTICS

ELECTRICAL CHARACTERISTICS

Items		Elect	rical Speci	ification		Test Condition	Remarks
	Symb.	Min.	Тур.	Max.	Unit		
Mode of Vibration		F	undament	tal			
Nominal Frequency	F0		40		MHz		
Nominal Temperature	T _{NOM}		+25		°C		
Load Capacitance	CL		8		pF		
Frequency Tolerance	df/F	-15		+15		+25±3°C	
Frequency Temperature Characteristics	df/F	-150		+150	PPM	-40 to +150 °C	Based on an oscillation frequency at +25 °C
Frequency Aging Rate		-2.0		+2.0		1 st year	+25±3°C
Equivalent Series Resistance	ESR			50	Ω		
Drive Level	Pd	0.01		200	μW		
Insulation Resistance	IR	500			MΩ	100V(DC)	

5 Measurement Condition

(1) Frequency measurement

Drive Level

Drive Level

Measuring instrument : IEC	PI-Network Test Fixture
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Load Capacitance : 8pF

. : 10µW

- (2) Equivalent series resistance (ESR) measurement
 - Measuring instrument : IEC PI-Network Test Fixture
 - Load Capacitance : Series
 - : 10µW

APPEARANCES, DIMENSIONS 6

(1) OUTLINE DIMENSION (not to scale)



(2) MARKING

2.

Nominal Frequency 1.

First 5 digits of the frequency is indicated.

- [K] mark is surely 1 pin direction.
- Date Code 3.

Identification

- Last 1 digit of YEAR and WEEK (Ex) 2022, Jan, 01 -> 201 Manufacturing Location Y...Japan (Yamagata)
- 4. 5. No.1 pin is expressed.

Note: The font of marking is for reference only.

90° 1.45 90° 90° 1.45 90° 1.45 90° 1.45 90° 1.45 90° 1.45 90° 1.45 90° 1.45

7 RECOMMENDED LAND PATTERN (not to scale)

UNIT : mm

8 TAPING & REEL

(1) Dimensions



(2) Leader and trailer tape



(3) Direction (The direction shall be seen from the top cover tape side)



(4) Specification

- 1. Material of the carrier tape is either polystyrene or A-PET (ESD).
- 2. Material of the cover tape is PET/PE (ESD).
- 3. The seal tape shall not cover the sprocket holes and not protrude from the carrier tape.
- 4. Tensile strength of carrier tape: 10N or more.
- 5. The R of the corner of each cavity is 0.2R max.
- 6. The alignment between centers of the cavity and sprocket hole shall be 0.05mm or less.
- 7. The orientation shall be checked from the top cover tape side as shown in 8-(3).
- 8. Peeling force of cover tape: 0.1 to 1.0N.
- 9. The component will fall out naturally when cover tape is removed and set upside down.

Cover tape 165° ~180 Career tape

KYOCERA Corporation

(5) Reel Specification



φ180 Reel (3,000pcs max.)

Symbol	А	В	С	D
Dimension	φ180 +0/-3	φ60 +1/-0	φ13±0.2	φ21 <u>±</u> 0.8
Symbol	E	W	t	
Dimension	2.0±0.5	9±1	2.0±0.5	

(Unit : mm)

φ330 Reel (15,000pcs max.)

Symbol	А	В	С	D
Dimension	φ330±2.0	φ100±1.0	φ13±0.2	φ21±0.8
Symbol	E	W	t	
Dimension	2.0±0.5	9.5±0.5	2.2±0.1	

(Unit:mm)

9 ENVIRONMENTAL AND MECHANICAL CHARACTERISTICS :

(The solder used for the test is Pb-Free Sn-3Ag-0.5Cu.) After following test, frequency shall not change more than $\pm 10 \times 10^{-6}$ and CI, $\pm 20\%$ or 5 Ω .

No	Stress	Reference	Additional Requirements
9.1	High Temperature Exposure	MIL-STD-202	1000 hrs. at rated operating temperature (e.g. 85°C part can
	(Storage)	Method 108	be stored for 1000 hrs at 85°C. Same applies for 125°C).
			Unpowered.
			Measurement at 24±4 hours after test conclusion.
9.2	Temperature Cycling	JESD22	1000 cycles (-40°C to 125°C) Note: If 85°C part the 1000
		Method JA-104	cycles will be at that temperature rating.
			Measurement at 24±4 hours after test conclusion.
			30min maximum dwell time at each temperature extreme. 1 min. maximum transition time.
9.3	Biased Humidity	MIL-STD- 202	1000 hours 85°C/85%RH. Rated VDD applied with 1 MW
9.5	Diased Fidificity	Method 103	and inverter in parallel, 2X crystal CL capacitors between
			each crystal leg and GND.
			Measurement at 24 ± 4 hours after test conclusion.
9.4	Operational Life	MIL-STD-202	Note: 1000 hrs @ 125°C. If 85°C part will be tested at that
		Method 108	temperature. Rated VDD applied with 1 MW and inverter in
			parallel, 2X crystal CL capacitors between each crystal leg
			and GND.
			Measurement at 24±4 hours after test conclusion.
9.5	Terminal Strength (Leaded)	MIL-STD-202	Test leaded device lead integrity only. Conditions: A (227 g),
		Method 211	C (227 g).
9.6	Resistance to Solvents	MIL-STD-202	Note: Also aqueous wash chemical - OKEM clean or
		Method 215	equivalent. Do not use banned solvents.
9.7	Mechanical Shock	MIL-STD-202	Figure 1 of Method 213. Condition C
9.8	Vibration	Method 213 MIL-STD-202	5g's for 20 minutes 12 cycles each of 3 orientations.
9.0	VIDIALION	Method 204	Note: Use 8"X5" PCB .031" thick with 7 secure points on
			one 8" side and 2 secure points on corners of opposite
			sides. Parts mounted within 2" from any secure point. Test
			from 10-2000 Hz.
9.9	Resistance to	MIL-STD-202	Condition B No pre-heat of samples. Note: Single Wave
	Soldering Heat	Method 210	solder - Procedure 1 with solder within 1.5 mm of device
			body for Leaded. Procedure 1 except 230°C and immerse
			only to level to cover terminals for SMD.
9.10	Solder ability	J-STD-002	For both Leaded & SMD. Electrical Test not required.
			Magnification 50 X. Conditions:
			Leaded: Method A @ 235°C, category 3.
			SMD: a) Method B, 4 hrs @ 155°C dry heat @ 235°C
			b) Method B @ 215°C category 3.
0.11		111.04	c) Method D category 3 @ 260°C.
9.11 9.12	Flammability Board Flex	UL-94 AEC Q200-005	V-0 or V-1 Acceptable 60 sec minimum holding time.
9.1Z			oo see minimum nolang ume.
9.13	Terminal Strength (SMD)	AEC Q200-006	-
0.10		,	

10 SOLDERING CONDITION

- Material of solder
 Kind ... lead free solder paste
 Melting point ... +220±5°C
- (2) Reflow temp.profile



- (3) Hand Soldering +350°C 3 sec max.
- (4) Reflow Times 2 times

11 CAUTIONS FOR USE

- Soldering upon mounting There is a possibility to influence product characteristics when solder paste or conductive glue comes in contact with product lid or surface.
- (2) When using mounting machine Please minimize the shock when using mounting machine to avoid any excess stress to the product.
- (3) Conformity of a circuit

We strongly recommend to make sure that Negative resistance (Gain) of IC is designed to be 10 times the ESR (Equivalent Series Resistance) of crystal unit.

12 STORAGE CONDITIONS

Please store product in below conditions, and use within 6 months. Temperature +18 to +30°C, and Humidity of 20 to 70 % in the packaging condition.

13 MANUFACTURING LOCATION

KYOCERA Corporation Yamagata Higashine Plant / Japan (Yamagata)

14 Quality Assurance

To be guaranteed by KYOCERA Corporation Yamagata Higashine Plant Quality Assurance Division

15 Quality guarantee

In case when KYOCERA Corporation rooted failure occurred within 1 year after its delivery, substitute product will be arranged based on discussion. Quality guarantee of product after 1 year of its delivery is waivered.

16 Others

In case of any questions or opinions regarding the Specification, please have it in written manner within 45 days after issued date.